Amendments to the Claims:

Please amend the claims as follows:

Claim 1 (currently amended) An apparatus for loading and unloading wafers to and from the fabrication equipment, <u>having a especially an apparatus with an improved main assembly, said</u> main assembly comprising:

a port plate;

a base;

two first and second port plate supporters each having a top end and a bottom end, with two lead screws and a lead device installed thereon, the top ends of said two port plate supporters being connected to said the port plate and, the bottom ends of said two port plate supporters being connected to said the base;

a first lead screw and corresponding lead device installed on the first plate supporter;

a second lead screw and corresponding lead device installed on the second plate supporter;

a port door with two screw nuts installed at opposite sides thereof, said the port door being coupled screwed to said the first and second two lead screws via said the two screw nuts;

a lifting/lowering drive mechanism installed on said the base, said lifting/lowering drive mechanism comprising a motor, timing pulleys, and timing belts, wherein the said lifting/lowering drive mechanism ean drives the first and second said lead screws to move said the port door upwards or downwards via said the timing pulleys and timing belts through the power generated by said the motor;

protective covers covering the first and second port plate supporters, repectively;

an intake filtering system having a filter installed in the base and a plurality of intake pipes installed at openings of the protective covers to form an air shield to prevent particles from going out and contaminating wafers; and

for each of the first and second lead screws, a spring grommet installed between a top end thereof and the port plate and a spring grommet installed between a bottom end thereof and the base for absorbing a pitch error between the screw nut and the corresponding lead screw.

Claim 2 (currently amended) The apparatus for loading and unloading wafers of claim 1, wherein the apparatus further comprises a pod hold-down latch mechanism module and a wafer reseat mechanism module are installed on said the port plate.

Claim 3 (canceled)

Claim 4 (currently amended) The apparatus for loading and unloading wafers of claim 1, wherein said each of the first and second port plate supporters are made of a U-shaped plates of with high rigidity.

Claim 5 (currently amended) The apparatus for loading and unloading wafers of claim 1, wherein the apparatus further comprises a pod unlock mechanism module is installed on said the port door.

Claim 6 (currently amended) The apparatus for loading and unloading wafers of claim 1, wherein two opposite-sides of-said the port door are secured to two drive plates, each of said two drive plates having a screw nut thereon to be screwed to said lead screw via said screw nut, two shaft bearings being installed on one of said two drive plates, said

two shaft bearings being slidably matched on two lead poles to form said lead device.

Claim 7 (canceled)

Claim 8 (currently amended) The apparatus for loading and unloading wafers of claim 1, wherein said the base has a plurality of positioning holes disposed thereon to be fixed on the fabrication equipment.

Claim 9 (currently amended) The apparatus for loading and unloading wafers of claim 1, wherein said the lifting/lowering drive mechanism also further has idle wheels contacting the sticking to said timing pulleys.